



# TF21084A

## Half -Bridge Driver

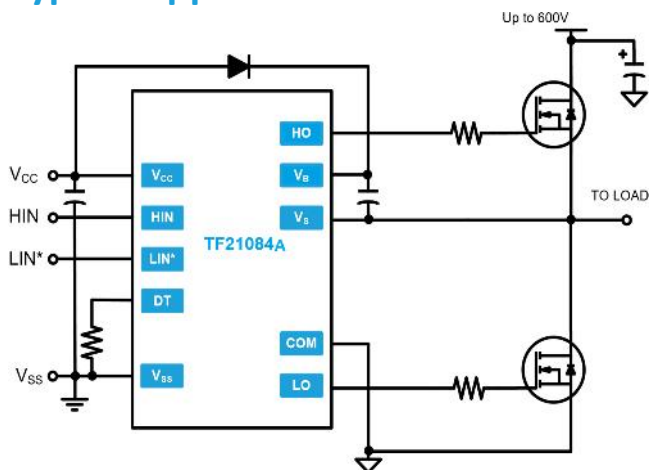
### Features

- Floating high-side driver in bootstrap operation to 600V
- Drives two N-channel MOSFETs or IGBTs in a half bridge configuration
- Outputs tolerant to negative transients
- Programmable dead time to protect MOSFETs
- Wide logic and low side gate driver supply voltage: 10V to 20V
- Wide logic supply voltage offset voltage: -5V to 5V
- Logic input (HIN and LIN\*) 3.3V capability
- Schmitt triggered logic inputs with internal pull down
- Undervoltage lockout for high and low side drivers
- Extended temperature range: -40°C to +125°C

### Applications

- DC-DC Converters
- AC-DC Inverters
- Motor Controls ■ Class D Power Amplifiers

### Typical Application



### Description

The TF21084A is a high voltage, high speed gate driver capable of driving N-channel MOSFETs and IGBTs in a half bridge configuration. TF Semiconductor's high voltage process enables the TF21084A's high side to switch to 600V in a bootstrap operation.

The TF21084A logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. Programmable dead time, by an external resistor, provides more system level flexibility.

The TF21084A is offered in PDIP-14 and SOIC-14(N) packages. It operates over an extended -40 °C to +125 °C temperature range.



SOIC-14(N)



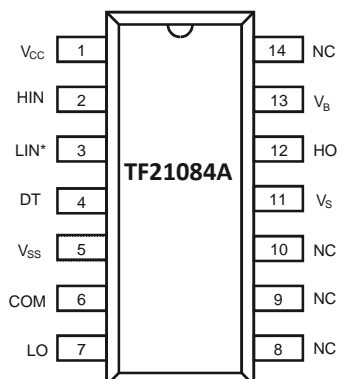
PDIP-14

### Ordering Information

Year Year Week Week

PART NUMBER	PACKAGE	PACK / Qty	MARK
TF21084A-TUU	SOIC-14(N)	Tube / 50	 YYWW TF21084A Lot ID
TF21084A-TUH		T&R / 2500	
TF21084A-3BS	PDIP-14	Tube / 25	 YYWW TF21084A Lot ID

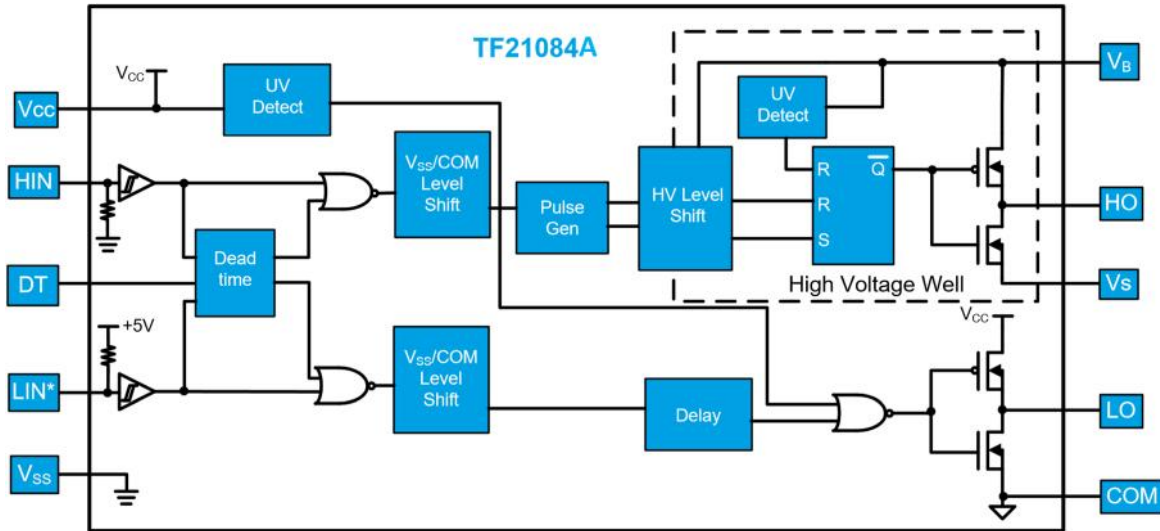
## Pin Diagrams

**Top View: SOIC-14, PDIP-14**


## Pin Descriptions

PIN NAME	PIN DESCRIPTION
HIN	Logic input for high-side gate driver output, in phase with HO (referenced to VSS).
LIN*	Logic input for low side gate driver output, out of phase with LO (referenced to VSS)
VSS	Logic ground
DT	Programmable deadtime lead, referenced to VSS.
COM	Low-side return
LO	Low-side gate drive output
V <sub>CC</sub>	Low-side and logic fixed supply
V <sub>B</sub>	High-side floating supply
HO	High-side gate drive output
V <sub>S</sub>	High-side floating supply return

**Functional Block Diagram**



## Absolute Maximum Ratings *(NOTE1)*

$V_B$  - High side floating supply voltage.....-0.3V to +624V  
 $V_S$  - High side floating supply offset voltage..... $V_B-24V$  to  $V_B+0.3V$   
 $V_{HO}$  - High side floating output voltage..... $V_S-0.3V$  to  $V_B+0.3V$   
 $dV_S/dt$  - Offset supply voltage transient.....50 V/ns  
 $V_{DT}$  - Programmable dead time pin voltage..... $V_{SS}-0.3V$  to  $V_B+0.3V$   
 $V_{CC}$  - Low side fixed supply voltage.....-0.3V to +24V  
 $V_{LO}$  - Low side output voltage.....-0.3V to  $V_{CC}+0.3V$   
 $V_{CC}$  - Logic supply voltage.....-0.3V to  $V_{SS}+24V$   
 $V_{SS}$  - Logic supply offset voltage..... $V_{CC}-25V$  to  $V_{CC}+0.3V$   
 $V_{IN}$  - Logic input voltage (HIN and LIN\*)..... $V_{SS}-0.3V$  to  $V_{CC}+0.3V$

$P_D$  - Package power dissipation at  $T_A \leq 25^\circ C$

SOIC14.....1.0W  
 PDIP14.....1.6W

**NOTE1** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## Recommended Operating Conditions

SOIC-14 Thermal Resistance *(NOTE2)*

$Q_{JA}$ .....120 °C/W

PDIP-14 Thermal Resistance *(NOTE2)*

$Q_{JA}$ .....75 °C/W

$T_J$  - Junction operating temperature .....+150 °C

$T_L$  - Lead temperature (soldering, 10s) ..... +300 °C

$T_{stg}$  - Storage temperature range .....-55 °C to +150 °C

**NOTE2** Thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Parameter	MIN	MAX	Unit
$V_B$	High side floating supply absolute voltage	$V_S + 10$	$V_S + 20$	V
$V_S$	High side floating supply offset voltage	<b>(NOTE 3)</b>	600	V
$V_{HO}$	High side floating output voltage	$V_S$	$V_B$	V
$V_{CC}$	Low side fixed supply voltage	10	20	V
$V_{LO}$	Low side output voltage	0	$V_{CC}$	V
$V_{IN}$	Logic input voltage (HIN & LIN*)	$V_{SS}$	5	V
$V_{DT}$	Programmable deadtime pin voltage	$V_{SS}$	$V_{CC}$	V
$V_{SS}$	Logic ground	-5	5	V
$T_A$	Ambient temperature	-40	125	°C

**NOTE3** Logic operational for  $V_S$  of -5 V to +600 V. Logic state held for  $V_S$  of -5 V to - $V_{BS}$ .

## DC Electrical Characteristics (NOTE4)

$V_{BIAS} (V_{CC}, V_{BS}) = 15V$ ,  $V_{SS} = COM$ , and  $T_A = 25\text{ }^\circ C$  unless otherwise specified.

Symbol	Parameter	Conditions	MIN	TYP	MAX	Unit
$V_{IH}$	Logic "1" input voltage	$V_{CC} = 10\text{ V to }20\text{ V}$	2.5			V
$V_{IL}$	Logic "0" input voltage				0.6	
$V_{OH}$	High level output voltage, $V_{BIAS} - V_O$	$I_O = 2\text{ mA}$		0.02	0.2	
$V_{OL}$	Low level output voltage, $V_O$	$I_O = 2\text{ mA}$		0.02	0.1	
$I_{LK}$	Offset supply leakage current	$V_B = V_S = 600V$			50	mA
$I_{BSQ}$	Quiescent $V_{BS}$ supply current	$V_{IN} = 0V\text{ or }5V$	20	75	130	
$I_{CCQ}$	Quiescent $V_{CC}$ supply current	$V_{IN} = 0V\text{ or }5V$ , $RDT = 0\text{ W}$	0.4	1.0	1.6	mA
$I_{IN+}$	Logic "1" input bias current	$HIN = 5V$ , $LIN^* = 0V$		5	20	mA
$I_{IN-}$	Logic "0" input bias current	$HIN = 0V$ , $LIN^* = 5V$			5	
$V_{BSUV+}$	$V_{BS}$ supply under-voltage positive going threshold		8.0	8.9	9.8	V
$V_{BSUV-}$	$V_{BS}$ supply under-voltage negative going threshold		7.4	8.2	9.0	
$V_{CCUV+}$	$V_{CC}$ supply under-voltage positive going threshold		8.0	8.9	9.8	
$V_{CCUV-}$	$V_{CC}$ supply under-voltage negative going threshold		7.4	8.2	9.0	
$V_{CCUV+}$	Hysteresis		0.3	0.7		V
$V_{BSUV+}$						
$I_{O+}$	Output high short circuit pulsed current	$V_O = 0V$ , $PW \leq 10\text{ ms}$	120	290		mA
$I_{O-}$	Output low short circuit pulsed current	$V_O = 15V$ , $PW \leq 10\text{ ms}$	250	600		

**NOTE4** The  $V_{IN}$ ,  $V_{TH}$ ,  $I_{IN}$  parameters are referenced to  $V_{SS}$  and are applicable to the two logic input pins:  $HIN$  and  $LIN^*$ . The  $V_O$  and  $I_O$  parameters are referenced to  $COM$  and are applicable to the respective output pins:  $HO$  and  $LO$ .

## AC Electrical Characteristics

$V_{BIAS} (V_{CC}, V_{BS}) = 15V$ ,  $V_{SS} = COM$ ,  $C_L = 1000$  pF, and  $T_A = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	MIN	TYP	MAX	Unit
$t_{ON}$	Turn-on propagation delay	$V_S = 0V$		220	300	ns
$t_{OFF}$	Turn-off propagation delay	$V_S = 0V$ or 600V		200	280	
$t_{DM ON}$	Delay matchng   $t_{ON} - t_{OFF}$			0	30	
$t_r$	Turn-on rise time	$V_S = 0V$		100	220	
$t_f$	Turn-off fall time			35	80	
$t_{DT}$	Deadtime: $t_{DT LO-HO}$ & $t_{DT HO-LO}$	$R_{DT} = 0W$	400	540	680	ms
		$R_{DT} = 200kW$ , <b>NOTES</b>	4	5	6	
$t_{MDT}$	Deadtime matching = $t_{DT LO-HO} - t_{DT HO-LO}$	$R_{DT} = 0W$		0	60	ns
		$R_{DT} = 200kW$		0	600	

**NOTES** Guaranteed by design, not tested in production

## Timing Waveforms

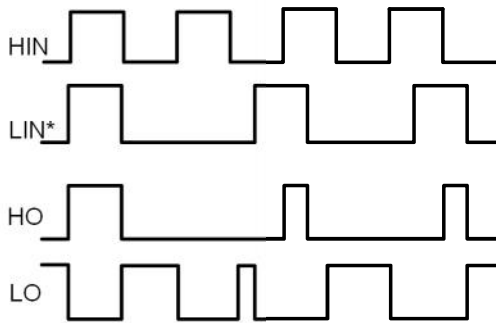


Figure 1. Input / Output Timing Diagram

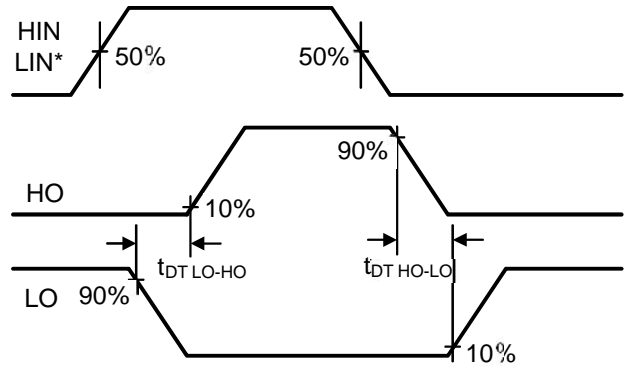


Figure 2. Deadtime Waveform Definitions

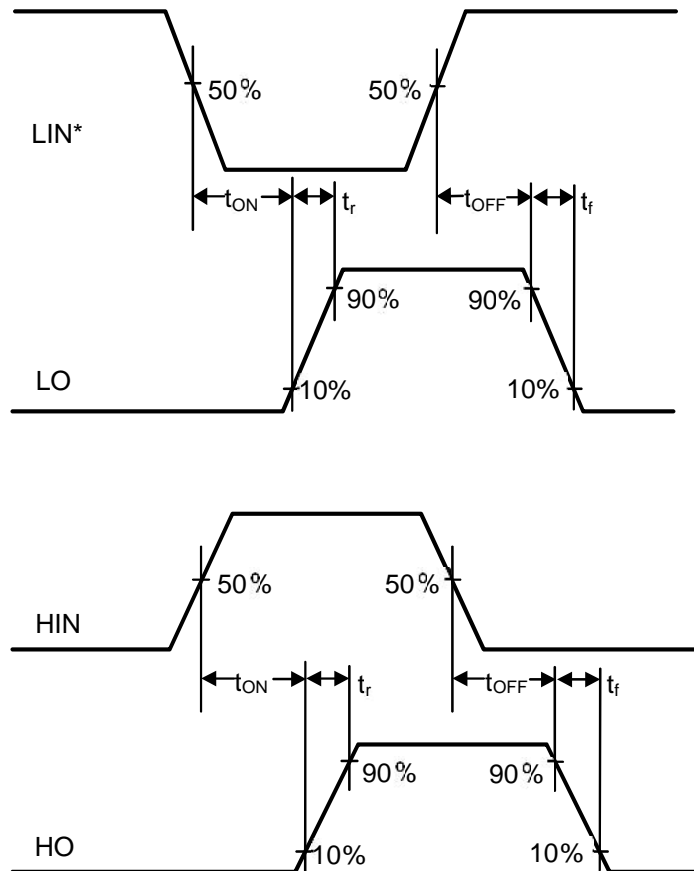


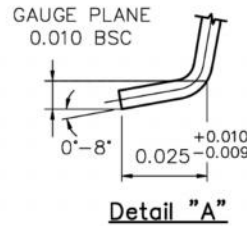
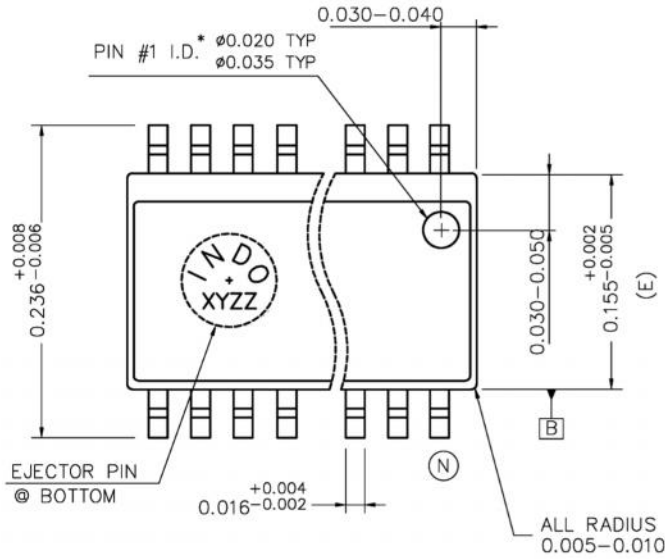
Figure 3. Switching Time Waveform Definitions

## Package Dimensions (SOIC-14N)

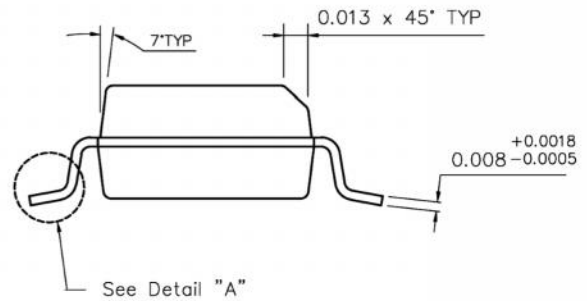
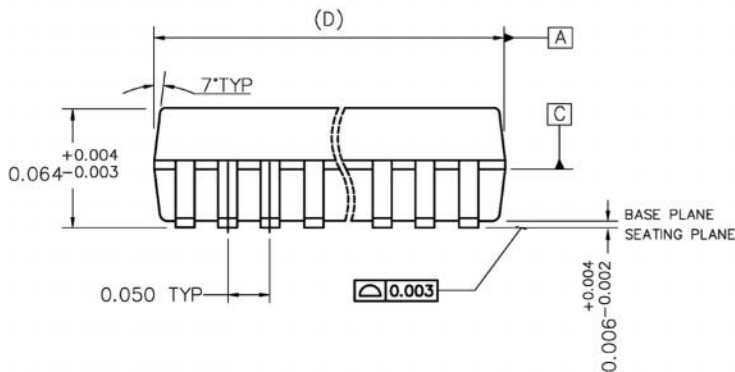
ALL DIMENSIONS ARE IN INCHES UNLESS OTHERWISE NOTED

NOTES:

1. "D" & "E" ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSION. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED 6 MILS PER SIDE.
2. "N" IS THE NUMBER OF TERMINAL POSITIONS.
3. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN 3 MILS! (● SEATING PLANE) OUTGOING ASSEMBLY & 4 MILS AFTER TEST.
4. THE BOTTOM PACKAGE LEAD SIDE MAY BE BIGGER THAN THE TOP PACKAGE LEAD SIDE BY 4 MILS (2 MILS PER SIDE). BOTTOM PACKAGE DIMENSION SHALL FOLLOW DIMENSION STATED IN THIS DRAWING.
5. THE BOTTOM EJECTOR PIN CONTAINS COUNTRY OF ORIGIN "INDO" AND MOLD ID. ( REFER TO TABLE FOR OPTION ).
6. THIS DRAWING CONFORMS TO JEDEC REF. MS-012 REV. E



N	D VARIATION			MGP MOLD	
	MIN	NOM	MAX	STANDARD PIN 1 I.D.	MATRIX EJECT PIN
08	0.189	0.193	0.196	N/A	YES
14	0.337	0.339	0.344	YES	NO
16	0.386	0.390	0.393	N/A	YES

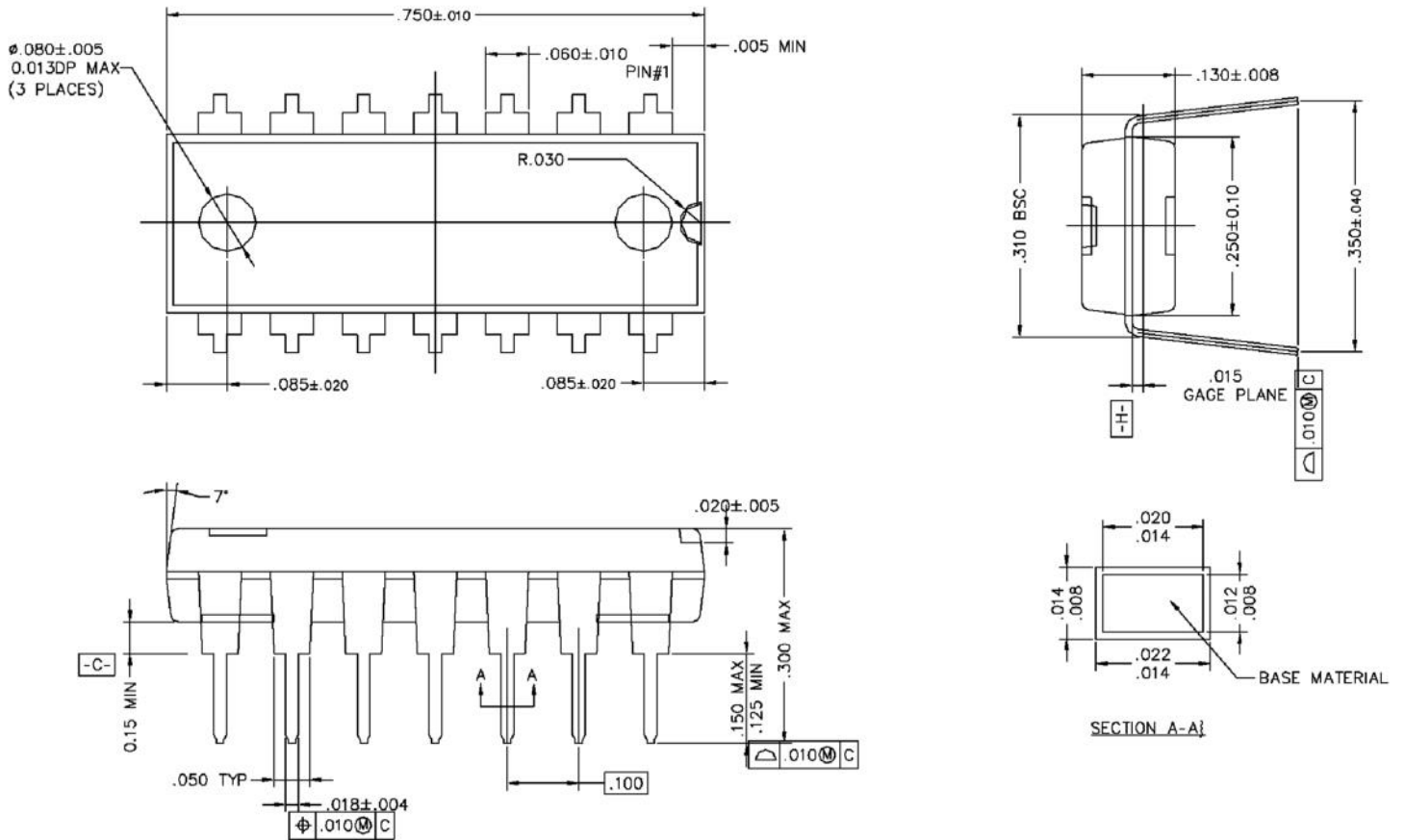


Please contact support@tfsemi.com for package availability.



## Package Dimensions (PDIP-14)

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Note: Drawing conforms to jedec ref. MS-001 rev D

Please contact [support@tfsemi.com](mailto:support@tfsemi.com) for package availability.

## Revision History

Rev.	Change	Owner	Date
1.0	First release, AI datasheet	Duke Walton	1/17/19

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